

PRM5R0N06D

PFC Device Corporation

60V Single N-Channel MOSFET

Major ratings and characteristics

Characteristics	Values	Units
V_{DS}	60	٧
$I_D^6 (T_C=25^{\circ}C)$	60	Α
Max. R _{DS(ON)} @V _{GS} =10V	5.0	mΩ
Max. R _{DS(ON)} @V _{GS} =4.5V	7.2	mΩ
T _J Operating Junction Temperature	-55 to +150	လူ

General Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

PRM5R0N06D TO-252 (D-PAK)

Typical Applications

- Charger Adapter
- Power Tools
- LED Lighting

Features

- Max. R_{DS(ON)}=5.0mΩ@V_{GS}=10V
- Improved dv/dt capability
- Fast switching
- 100% E_{AS} Guaranteed
- Green Device Available

1. Characteristics

Maximum Ratings Characteristics

($T_A = 25$ °C unless otherwise specified)

Symbol	Parameter	Rating	Units
$V_{ t DS}$	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	±20	V
I _D ⁵	Drain Current – Continuous (T _C =25°C)	97	Α
ID	Drain Current – Continuous (T _C =100°C)	61	Α
I_D^6	Drain Current – Continuous (T _C =25°C)	60	Α
I _{DM}	Drain Current – Pulsed ¹	240	Α
E _{AS}	Single Pulse Avalanche Energy ²	48	mJ
I _{AS}	Single Pulse Avalanche Current ²	31	Α
P _D	Power Dissipation (T _C =25°C)	78	W
FD	Power Dissipation – Derate above 25°C	0.62	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		62	°C/W
R _{eJC}	Thermal Resistance Junction to Case		1.6	°C/W



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Electrical Characteristics

 $\overline{(T_J)}$ = 25 °C unless otherwise specified)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	60			V
	Davis Course Landaux Course	V _{DS} =60V, V _{GS} =0V, T _J =25°C			1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =60V, V _{GS} =0V, T _J =125°C			250	uA
lass	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA

On Characteristics

В	R _{DS(ON)} Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A		4.2	5.0	mΩ
NDS(ON)		V _{GS} =4.5V, I _D =10A		5.7	7.2	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=250uA$	1.0	1.7	2.5	V
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =20A		61		S

Dynamic and switching Characteristics

Q _g	Total Gate Charge ^{3, 4}	V _{DS} =30V, V _{GS} =10V, I _D =10A	 49.5	
Q_gs	Gate-Source Charge ^{3, 4}		 9	 nC
Q_gd	Gate-Drain Charge ^{3, 4}		 8.4	
$T_{d(on)}$	Turn-On Delay Time ^{3, 4}		 25	
T_r	Turn-On Rise Time ^{3, 4}	V_{DD} =30V, V_{GS} =10V, R_G =6 Ω	 62	 ns
$T_{d(off)}$	Turn-Off Delay Time ^{3, 4}	I _D =10A	 83	 115
T_f	Turn-Off Fall Time ^{3, 4}		 87	
C_{iss}	Input Capacitance	V _{DS} =25V, V _{GS} =0V, f=1MHz	 2797	
C _{oss}	Output Capacitance		 1057	 pF
C_{rss}	Reverse Transfer Capacitance		 47	
R_{g}	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	 1.0	 Ω

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	$V_{GS}=0V$, $I_{S}=1A$	 	1.0	V
t _{rr}	Reverse Recovery Time	1 201 di/dt 1001/up	 35		ns
Q_{rr}	Reverse Recovery Charge	I _S =20A, di/dt=100A/us	 22		nC

Note :

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. V_{DD} =50V, V_{GS} =10V, L=0.1mH, R_G =25 Ω , Starting T_J =25 $^{\circ}$ C
- 3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 4. Essentially independent of operating temperature.
- 5. Silicon limited.
- 6. Package limited.

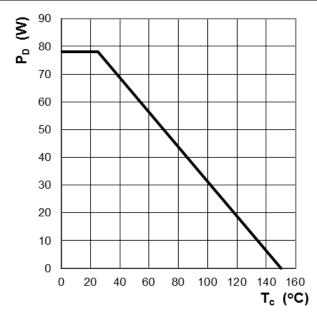


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2. Characteristics Curves

Ratings and Characteristics Curves

(T_A = 25°C unless otherwise specified)



€ 100 90 م 80 70 60 50 40 30 20 10 25 50 75 100 125 150 T_c (°C)

Figure 1: Power Dissipation

Figure 2: Continuous Drain Current vs. T_C

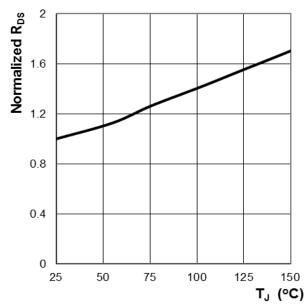


Figure 3: Normalized R_{DS(ON)} vs. T_J

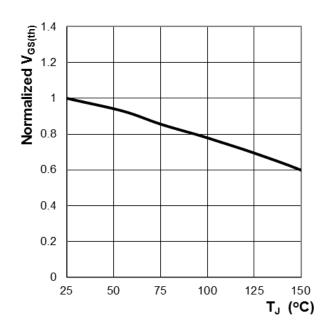


Figure 4: Normalized $V_{GS(th)}$ vs. T_J



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Ratings and Characteristics Curves

(T_A = 25°C unless otherwise specified)

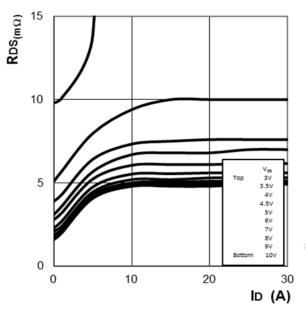


Figure 5: RDS(ON) vs. Drain Current and Gate Voltage

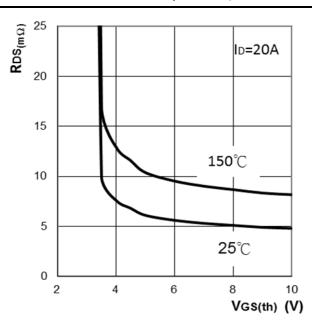


Figure 6: RDS(ON) vs. Gate Voltage

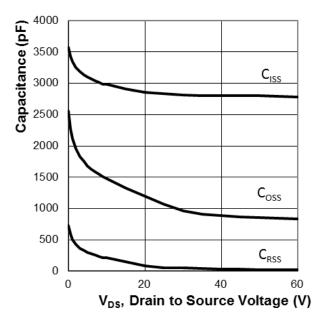


Figure 7: Typ. Capacitance Characteristics

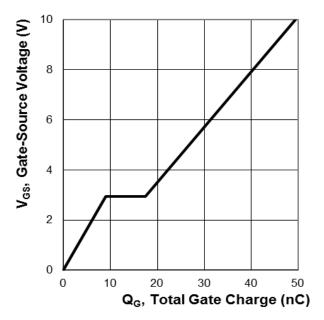


Figure 8: Typ. Gate Charge Characteristics



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Ratings and Characteristics Curves

(T_A = 25°C unless otherwise specified)

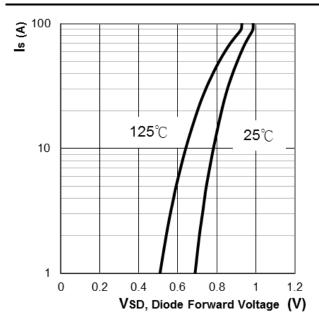


Figure 9: Body Diode Characters

Figure 10: Maximum Safe Operation Area

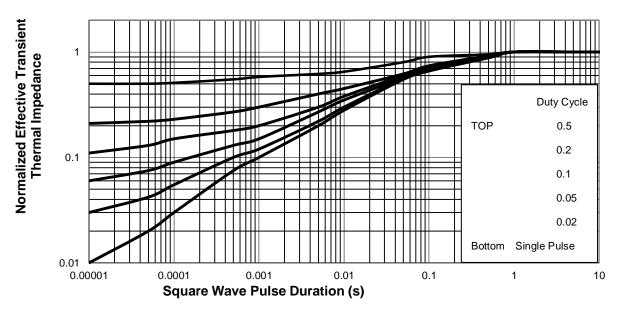


Figure 11: Normalized Thermal Transient Impedance, Junction-to-Case



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3. Marking information

Top Marking Rule

PFC PRM
5R0N06D
YYWW ABSH

PRM5R0N06D = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

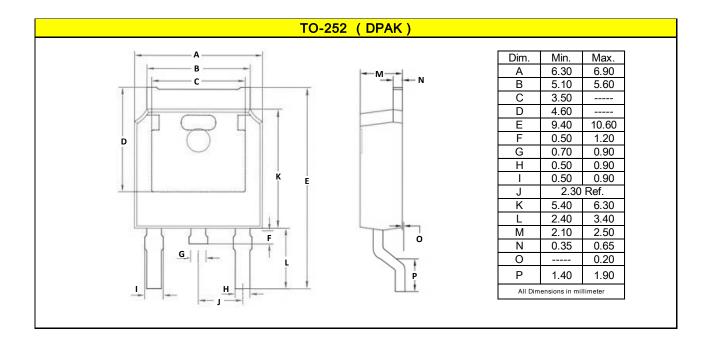
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

4. Package information

Package Outline Dimensions millimeters





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5. Ordering information

Part Number	Package	Delivery mode
PRM5R0N06D	TO-252 (D-PAK)	2500 pcs / 13" diameter reel

Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0

■ Device Weight: 0.01 ounces (0.3grams) - TO-252 (D-PAK)

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